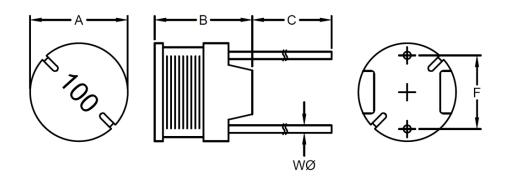
1. Part No. Expression

RCC0805100 M Z F

- (a)
- (b)
- (c) (d) (e) (f)
- (a) Series Code

- (d) Tolerance Code
- (b) Dimension Code
- (e) Special Code
- (c) Inductance Code
- (f) Packaging Code

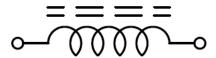
2. Configuration & Dimensions (Unit: mm)



Note: Marking: Inductance Code

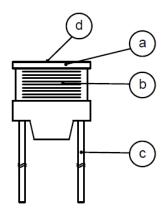
А	В	С	F	W
7.80±0.50	5.50 Max	15.00±3.00	5.00±0.50	0.65±0.10

3. Schematic





4. Material List



- (a) Core
- (b) Wire
- (c) Lead
- (d) Ink

5. General Specifications

- (a) Operating Temp.: 40°C to + 85°C (including self-temperature rise)
- (b) Storage Temp.: -40°C to +125°C (on board)
- (c) Heat Rated Current (Irms) will cause the coil temperature rise ΔT of 40°C Max.
- (d) Saturation Current (Isat) will cause inductance L0 to drop 10% Max.
- (e) Storage Condition (Component in its packaging)
 - i) Temperature: Less than 40°C
 - ii) Humidity: Less than 60% RH

6. Electrical Characteristics

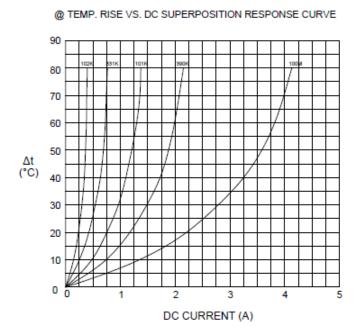
Part Number	Inductance (µH) @0A	Test Frequency	RDC (Ω) Max	IDC (A) Max
RCC0805100MZF	10	1V/2.52MHz	0.07	2.50
RCC0805120MZF	12	1V/2.52MHz	0.08	2.40
RCC0805150MZF	15	1V/2.52MHz	0.09	2.10
RCC0805180MZF	18	1V/2.52MHz	0.10	2.00
RCC0805220KZF	22	1V/2.52MHz	0.12	1.70
RCC0805270KZF	27	1V/2.52MHz	0.14	1.60
RCC0805330KZF	33	1V/2.52MHz	0.17	1.40
RCC0805390KZF	39	1V/2.52MHz	0.21	1.30
RCC0805470KZF	47	1V/2.52MHz	0.24	1.20
RCC0805560KZF	56	1V/2.52MHz	0.31	1.10
RCC0805680KZF	68	1V/2.52MHz	0.34	1.00
RCC0805820KZF	82	1V/2.52MHz	0.40	0.93
RCC0805101KZF	100	1V/1KHz	0.52	0.81
RCC0805121KZF	120	1V/1KHz	0.59	0.76
RCC0805151KZF	150	1V/1KHz	0.71	0.67
RCC0805181KZF	180	1V/1KHz	0.89	0.62
RCC0805221KZF	220	1V/1KHz	1.04	0.54
RCC0805271KZF	270	1V/1KHz	1.28	0.49
RCC0805331KZF	330	1V/1KHz	1.47	0.44
RCC0805391KZF	390	1V/1KHz	1.67	0.41
RCC0805471KZF	470	1V/1KHz	1.95	0.38
RCC0805561KZF	560	1V/1KHz	2.83	0.35
RCC0805681KZF	680	1V/1KHz	3.25	0.32
RCC0805821KZF	820	1V/1KHz	3.82	0.31
RCC0805102KZF	1000	1V/1KHz	5.28	0.25

Note:

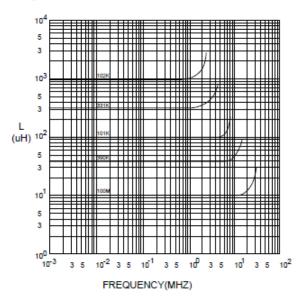
Tolerance code: K=±10%, M=±20%



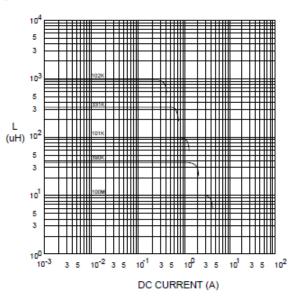
7. Characteristics Curves





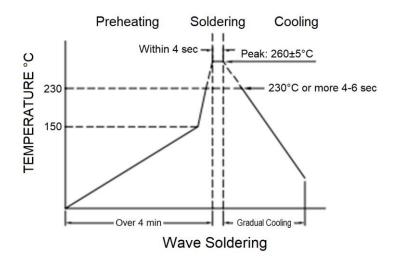


@ INDUCTANCE VS. DC SUPERPOSITION RESPONSE CURVE



8. Soldering Specification

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for wave soldering.



9. Packaging Information (Unit: Pcs)

INNER PACKAGE	INNER PACKAGE Q'TY		
TRAY	160		

Application Notice

1. Storage Conditions

To maintain the solderability of terminal electrodes:

- (a) Recommended products should be used within 12 months from the time of delivery.
- (b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation

- (a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- (b) Vacuum pick up is strongly recommended for individual components.
- (c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

